

12,00

SPECIFICATION

MARK DATE

REMARKS

- 1.MECHANICAL DATA PERMISS, AMBIENT TEMP. -40°C - +85°C POSITIONS PER ROTATION MECH. LIFETIME MIN. 10° STEPS TORQUE MIN, 0,7NCm 10, 16(NON-SELF-LOCKING)
- 2. ELECTRICAL DATA CONTACT RESISTANT < 80m0hm CONTACT LOAD. STATIC <= 0.2A INSULATION RESISTANCE > 100MOhm NORMAL AND TEST VOLTAGE 250V 50Hz/1min CONTACT LOAD. DYNAMIC <= 0.15A OPERATING VOLTAGE <=42V
- 4. LIFE Cycle : 10,000 Steps 3. SOLDER RECOMMENDATIONS SOLDER BATH MAX. 10s/260°C SOLDER IRON MAX, 25/340°C

2.20

4.30 6.80

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SM SWITCH CO., LTD.

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1. Style:

This specification describes "Rotary Switch" mainly used as signal switch of electric devices with the general requirements of mechanical and electrical characteristics.

1.1 Operating / Storage Temperature Range : $-40\% \sim +85\%$

2. Current Range:

2.1 None-Switching : 200 mA, 42V 2.2 Switching : 150 mA, 42V

3. Type of Actuation: Rotating

4. Test Sequence

	ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
E L E	1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product
E C T R I C P E P	2	Contact Resistance	 To be measured between the two terminals associated with each switch pole Measurements shall be made with a 1kHz shall current contact resistance meter 	80m Ω max.(initial)
R F O R	3	Insulation Resistance	250V DC, 1minute ±5seconds	100MΩ min
M A N C E	4	Dielectric withstanding Volotage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame For 1 minute	There shall be no breakdown or flashover
M A C H I N	5	Operation Force	Applied in the direction of operation	700gf/cm. max



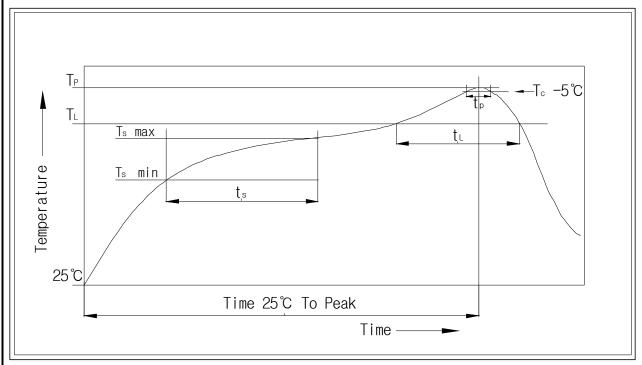
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P E R F O R M A N C E	6	Operation Life	Measurements shall be made following the test set forth below: 1)150mA, 42V DC resistive load 2)Rate of operation: 15~20 cycles/ minute 3)Step of operation: 10,000 steps	1)As shown in item 3,4 2)Contact Resistance: 200mΩ max 3)Final-after test
	7	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1) Temperature: -60° $\pm 3^{\circ}$ 2) Time: 96 hours	1)As shown in item 3~5 2)Contact Resistance: 200mΩ max
W E A T H E R O O F	8	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1) Temperature: $125\% \pm 2\%$ 2) Time: 96 hours	1)As shown in item 3~5 2)Contact Resistance: 200mΩ max
	9	Resistance Humidity	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1) Temperature: $40\% \pm 2\%$ 2) Relative humidity: $90 \sim 95\%$ 3) Time: 96 hours	1)As shown in item 4 2)Contact Resistance: 200mΩ max 3)Insulation Resistance: 10MΩ min



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5. Reflow Soldering Conditions:



1) Classification Reflow Profiles

Profile Feature	Pb-Free Assembly
Average Ramp-UP Rate(Ts max to Tp)	3℃/second max
Preheat - Temperature Min(Ts min) - Temperature Max(Ts max) - Time (ts min to ts max)	150℃ 200℃ 60-180seconds
Time maintained above: $ \begin{tabular}{ll} \hline - & Temperature & (T_L) \\ \hline - & Time & (t_L) \\ \hline \end{tabular} $	217℃ 60-150seconds
Peak/Classification Temperature(T _P)	260℃ +0℃/ -5℃
Time within 5℃ of actual Peak Temperature(tp)	min 30 seconds
Ramp-Down Rate	6 ℃/sec max
Time 25°C to Peak Temperature	8 minutes max

6. This item is "ROHS" Compliant



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7. Part List

NO	PART NAME	Q'TY	MATERIALS	TREATMENT	REMARK
1	COVER	1	LCP		Print
2	BASE	1	LCF		
3	ACTUATOR	1	PA66, STS		
4	CONTACT & TERMINAL	1	PHOSPHOR BRONZE	CONTACT AND TERMINAL PLATING: GOLD PLATING OVER NICKEL	Au 0.07μm Min Ni 0.1μm Min
5	PCB	1	EPOXY	PLATING: GOLD PLATING	Au 0.05 µm Min
6	O-Ring	1	SILICONE		